

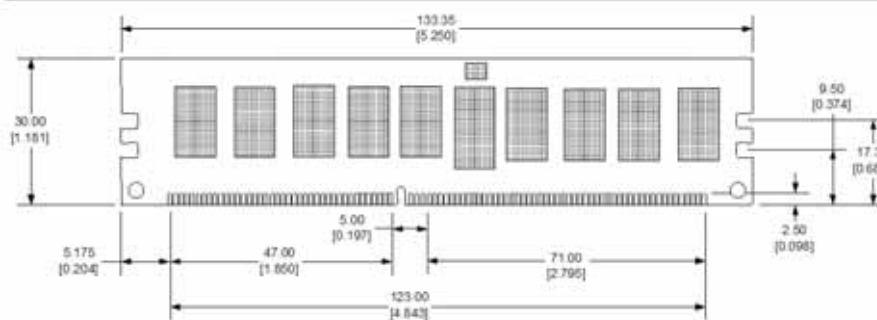
Products in Family

GRSX2270-13/2GB (1 x 2GB 1Rx4 DIMMs)
 GRSX2270-813/2GB (1 x 2GB 2Rx8 DIMMs)
 GRSX2270-13/4GB (1 x 4GB 2Rx4 DIMMs)
 GRSX2270-13/8GB (1 x 8GB 2Rx4 DIMMs)



Features		Description
240-pin JEDEC-compliant DIMMs 133.35 mm wide by 30 mm high (1.181" x 5.25") Data Transfer Rate: 10.6 Gigabytes/sec Operating Voltage: 1.5 V ±0.075 Fully RoHS Compliant Thermal Sensor		Each GRSX2270-13 upgrade consists of a single DDR3-1333 Registered ECC DIMM that conforms to JEDEC's DDR3, PC3-10600 standard. One 2K-bit EEPROM is used for Serial Presence Detect and a combination register/PLL with Address and Command Parity is also used. A thermal sensor accurately monitors the DIMM module and can prevent exceeding the maximum operating temperature of 95C.
Dataram Product	Sun Microsystems Product	Supported in these Sun Microsystems systems:
GRSX2270-13/2GB GRSX2270-813/2GB GRSX2270-13/4GB GRSX2270-13/8GB	X8337A Not Offered by Sun X8338A, X8359A Not Offered by Sun	Sun Fire X2270, X2270 M2

Front view

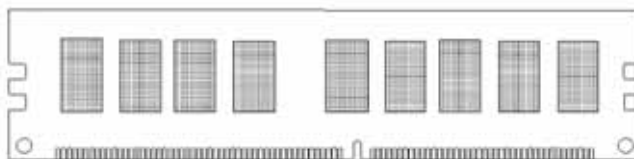


Notes

Tolerances on all dimensions except where otherwise indicated are $\pm$.13 (.005).

All dimensions are expressed in millimeters [inches]

Back view



Side view

